# OP \$40.00 11246

# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Georg Meyer- Berg	10/17/2005

### **RECEIVING PARTY DATA**

Name:	Infineon Technologies AG	
Street Address:	StMartin-Str. 53	
City:	Munich	
State/Country:	GERMANY	
Postal Code:	81669	

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11246563

### **CORRESPONDENCE DATA**

Fax Number: (301)762-4056

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 301/424-3640

Email: cag@usiplaw.com,aja@usiplaw.com

Correspondent Name: Andrew J. Aldag - ESF, LLC

Address Line 1: 1901 Research Blvd.

Address Line 2: Suite 400

Address Line 4: Rockville, MARYLAND 20850

NAME OF SUBMITTER: Andrew J. Aldag

Total Attachments: 1

source=exe asg 11246563#page1.tif

PATENT REEL: 016857 FRAME: 0921

### **ASSIGNMENT**

For good and valuable consideration, I, Georg Meyer-Berg, a citizen of Germany, residing at Hofangerstr. 71 A 81735 Müchen Germany; hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation, organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Str. 53, 81669 Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and filed herewith, entitled:

# Multichip Module Including a Plurality of Semiconductor Chips, and Printed Circuit Board Including a Plurality of Components

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:

\_\_\_

DATE: 2005-10-17

1

GESAMT SEITEN 05

**PATENT** 

REEL: 016857 FRAME: 0922